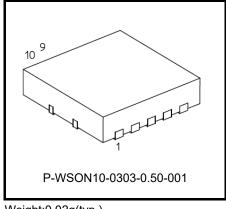


Toshiba Intelligent Power Device Silicon Monolithic Power MOS Integrated Circuit

TPD1055FA

For Motor, Solenoid and Lamp High side power switch

TPD1055FA is a High-side switch of a P channel DMOS output. It is monolithic power IC that can be driven directly from a CMOS or TTL logic circuit (MPU etc.), and was equipped with the intelligent function of protection and diagnosis.

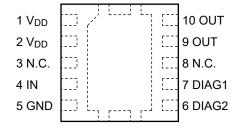


Weight: 0.02g(typ.)

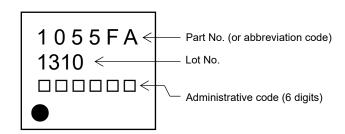
Features

- A monolithic power IC with a structure combining a control block and a power MOSFET (D-MOS) on single chip.
- One side of load can be grounded to a high-side switch.
- AEC-Q100 qualified.
- Can directly drive a power load from CMOS or TTL logic.
- Built-in protection circuits against over temperature, over current.
- · Incorporates a diagnosis function that allows diagnosis output to be read externally at battery short, load short-circuiting, opening, or over temperature.
- Up to V_{DD} 40V (Min) of counter electromotive force from an inductance load can be applied.
- Low on-resistance: $R_{DS(ON)}=0.12\Omega(Max)$ (@ $V_{DD}=12$ V, $T_{ch}=25^{\circ}$ C, $I_{O}=-2$ A)
- WSON10 package for surface mounting that is packed in embossed tape.

Pin Assignment (top view)



Marking

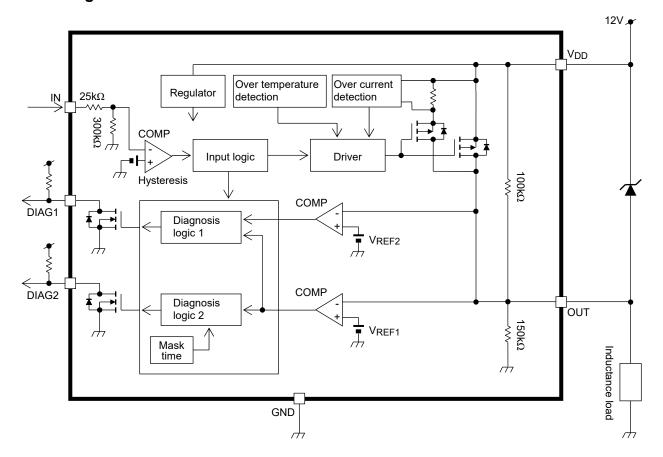


Due to its MOS structure, this product is sensitive to static electricity.

Start of commercial production



Block Diagram



Pin Description

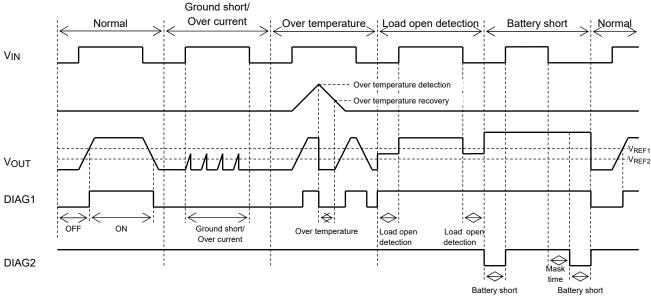
Pin No	Symbol	Function
1,2	V _{DD}	Power pin.
4	IN	Input pin. Input is connected to GND pin with pull down resistor. Even if the input is open, output will not accidentally turn on.
5	GND	Ground pin.
6	DIAG2	Self-diagnosis detection pin. It detects battery short. N-channel open drain.
7	DIAG1	Self-diagnosis detection pin. It detects load open, overcurrent, overtemperature. N-channel open drain.
9,10	OUT	Output pin. When the load is short-circuited and current in excess of the detection current (3A min) flows to the output pin, the output automatically turns on or off.
3,8	N.C.	No-Connect pin.

^{*}Exposed Pad has to be connected to GND pattern because of stability operation and heat radiation.

^{*}Please use N.C. pin in opening or GND connection.







Truth Table

Input signal V _{IN}	Output voltage VouT	Output state	Operating state
L	L	Off	Names
Н	Н	On	Normal
L	H(Note 1)	Off	l and an an data than
Н	Н	On	Load open detection
L	Н	Off	B # 1 /
Н	Н	On	Battery short
L	L	Off	Ground short /
Н	L	Current limit (Switching)	Over current
L	L	Off	0
Н	L	Off	Over temperature

Note 1: Internal voltage in TPD1055FA and external voltage decide this output voltage.

Input signal Vin	Outrot out to	Diagnosis state					
	Output voltage Vout	VDIAG1		VDIAG2			
VIN	VOUT		State		state		
	VOUT <vref2< td=""><td>L</td><td>Normally off</td><td>Н</td><td>-</td></vref2<>	L	Normally off	Н	-		
L	V _{REF2} ≤V _{OUT} <v<sub>REF1</v<sub>	Н	Load open detection	Н	-		
	V _{REF1} ≤V _{OUT}	Н	•	L	Battery short		
Н	V _{REF1} ≤V _{OUT}	Н	Normally on	Н	-		
	V _{OUT} <v<sub>REF1</v<sub>	L	Over current(Load short)/ Over temperature	Н	-		

 V_{REF2} : V_{IH} =1.8 $V(Typ.) / V_{IL}$ =1.6V(Typ.) * Hysteresis 0.2<math>V

 $V_{REF1} : V_{IH} = V_{DD} - 1.0 V(Typ.) \ / \ V_{IL} = V_{DD} - 1.5 V(Typ.) \quad * \ Hysteresis \ 0.5 V$



Absolute Maximum Ratings ($T_a = 25$ °C)

Characteristics		Symbol	Rating	Unit	Note	
Drain-source voltage		V_{DS}	40.0	V	P channel	
Supply voltage	DC	V _{DD(1)}	-0.3 to 25.0	V	-	
	Pulse	V _{DD(2)}	40.0	٧	Range exceeding 25.0V is within 0.3s.	
Input voltage		V _{IN}	-0.3 to 6.0	V	-	
Diagnosis output voltage		V _{DIAG}	-0.3 to 6.0	V	<u>-</u>	
Output voltage		V _{OUT}	(V _{DD} -40.0) to (V _{DD} +0.3)	V	-	
Output current		lo	Internally Limited	Α	-	
Diagnosis current		I _{DIAG}	5	mA	-	
Power dissipation		PD	1.84	W	Note2	
Operating temperature		Topr	-40 to 125	°C	-	
Channel temperature		T _{ch}	150	°C	-	
Storage temperature		T _{stg}	-55 to 150	°C	-	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Resistance

Characteristic	Symbol	Rating	Unit
Channel to ambient thermal resistance	R _{th(ch-a)}	67.6	°C /W

Test conditions

Note 2:

Glass epoxy board Material: FR-4(4 layer)

Size: 76.2mm * 114.3mm * 1.6mm

Via: Ø0.3mm (2 points)



Electrical Characteristics

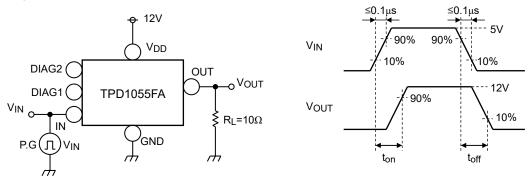
(Unless otherwise specified, Tch = -40 to 125 °C, Vdd = 5 to 18 V)

Characteristics		Symbol	Test circuit	Test condition	Min	Тур.	Max	Unit
Operating supply voltage		$V_{DD(opr)}$	-	-	5	-	18	V
Negative output voltage that can be applied to output		V _{OUT(neg)}	-	V _{IN} =0V	VDD-40	-	-	٧
Supply current		I _{DD(off)}	-	V _{IN} =0V, Output open	-	1.0	2.5	mA
		I _{DD(on)}	-	V _{IN} =5V, Output open	1	1.2	3.0	mA
1		V _{IH}	-	-	2.0	-	-	٧
Input voltage		V _{IL}	-	-	-	-	0.8	V
		I _{IN(1)}	-	V _{IN} =5V	-	15	50	μΑ
Input current		I _{IN(2)}	-	V _{IN} =0V	-1	-	1	μΑ
On resistance		R _{DS(ON)}	-	V _{DD} =8 to 18V, I _O =-2A, T _{ch} =25°C	-	0.08	0.12	Ω
Output leakage current		loL	-	V _{IN} =0V, V _{OUT} =0V	-500	-120	-	μА
Diagnosis output voltage	"L"-level	V_{DL}	-	I _{DIAG} =1mA	-	0.15	0.40	V
Diagnosis output current	"H"-level	I _{DH}	-	V _{DIAG} =5V	-	-	10	μА
Over current detection		loc	-	-	-9	-5	-3	Α
Over current off time		Short-Toff	-	V _{DD} =12V, R _L =0.1Ω, T _{ch} =25°C	3.3	8.0	15.0	ms
Over temperature	Temperature	Тот	-	-	150	170	200	°C
detection	Hysteresis	ΔТот	-	-	-	5	-	°C
Load open detection resistance		Rop	-	V _{IN} =0V	1	20	200	kΩ
Load open detection voltage		V _{OUT(OP)}	-	V _{IN} =0V	-	0.6*V _{DD}	0.7*V _{DD}	V
Battery short detection voltage	Temperature	V _{REF1}	-	V _{IN} =0V, V _{OUT} =L to H	V _{DD} -1.5	V _{DD} -1.0	V _{DD} -0.7	V
	Hysteresis	ΔV_{REF1}	-	-	-	0.5	-	V
Battery short detection mask time		Tmask	-	V _{OUT} =V _{DD} , V _{IN} ₹to DIAG2 ₹	50	110	200	μS
Switching time		ton	1	V _{DD} =12V, R _L =10Ω, T _{ch} =25°C	-	20	50	μS
gg		toff			-	20	50	μS

^{*}Typical characteristic conditions are V_{DD}=12V, T_{ch}=25°C.

Test Circuit 1

Switching times ton, toff



^{*}Because TPD1055FA does not have output clamp circuit, in the case of inductance load, connect flywheel diode.

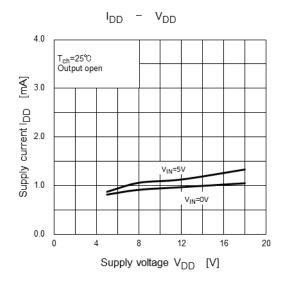
^{*}Sink current to this IC is expressed by "+", source current from this IC is expressed by "-".

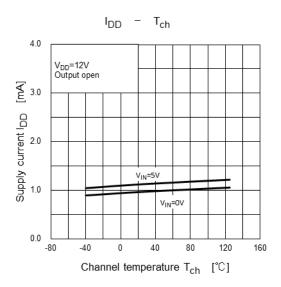
^{*}The voltage range that can detect difference between Load open and battery short is $V_{DD} \ge 7V$.

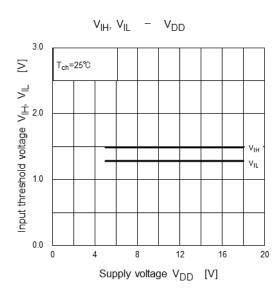


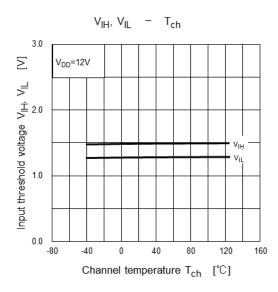
Characteristic curves

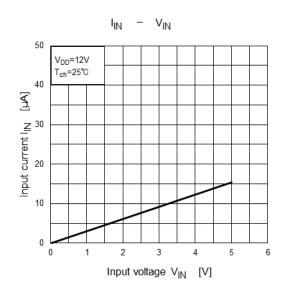
The below characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

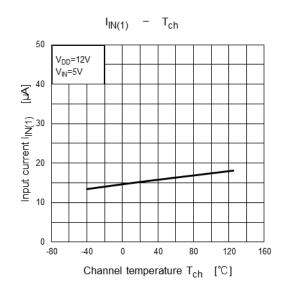




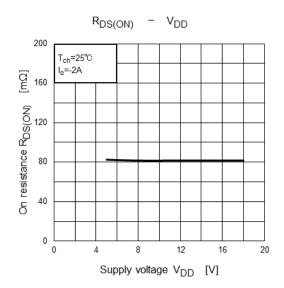


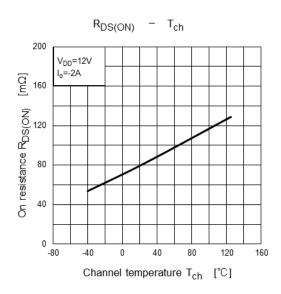


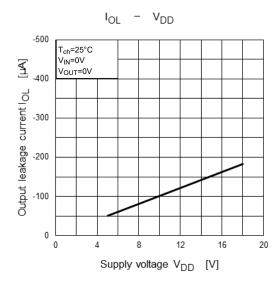


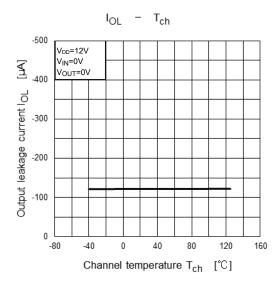


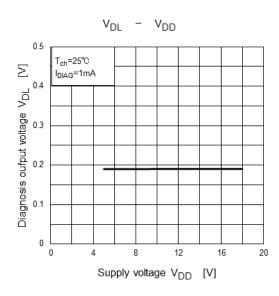


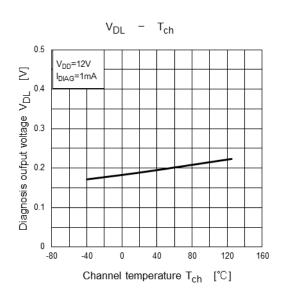




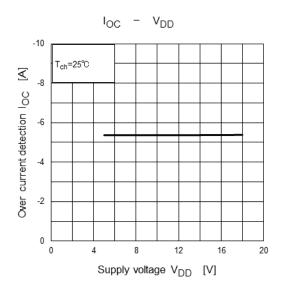


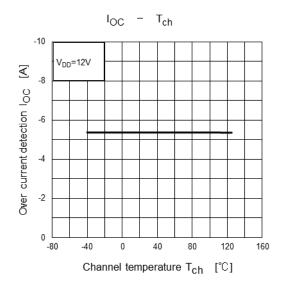


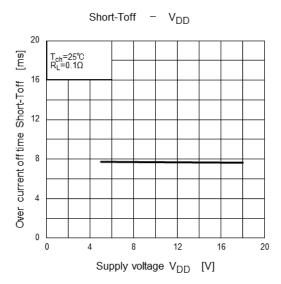


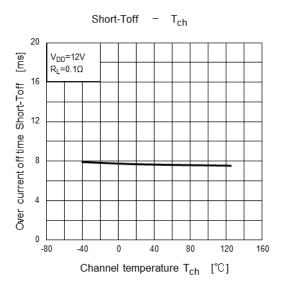


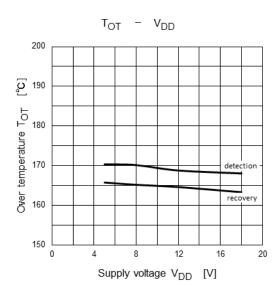




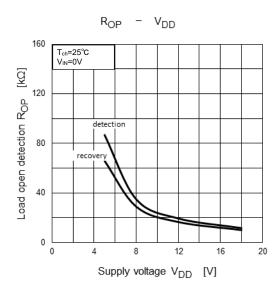


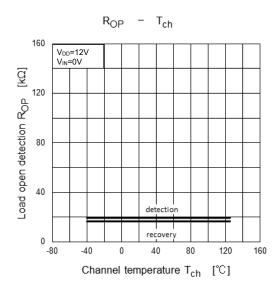


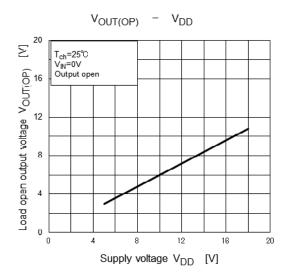


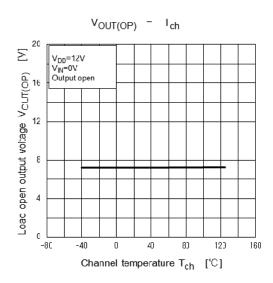


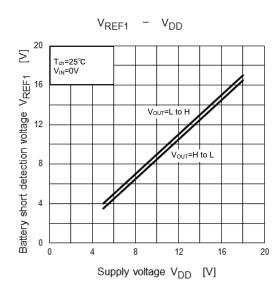


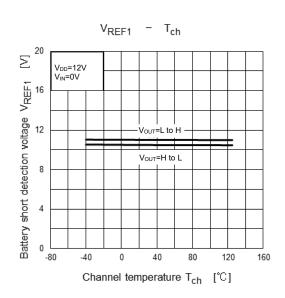




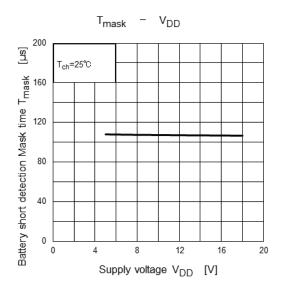


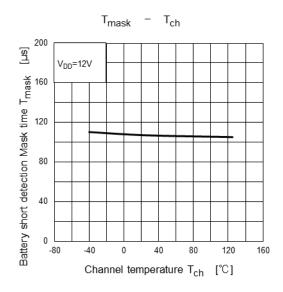


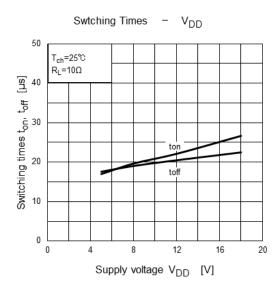


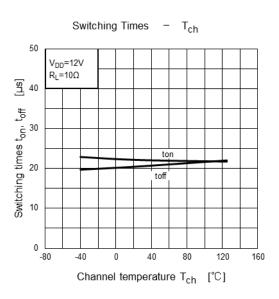


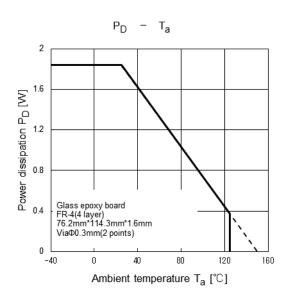








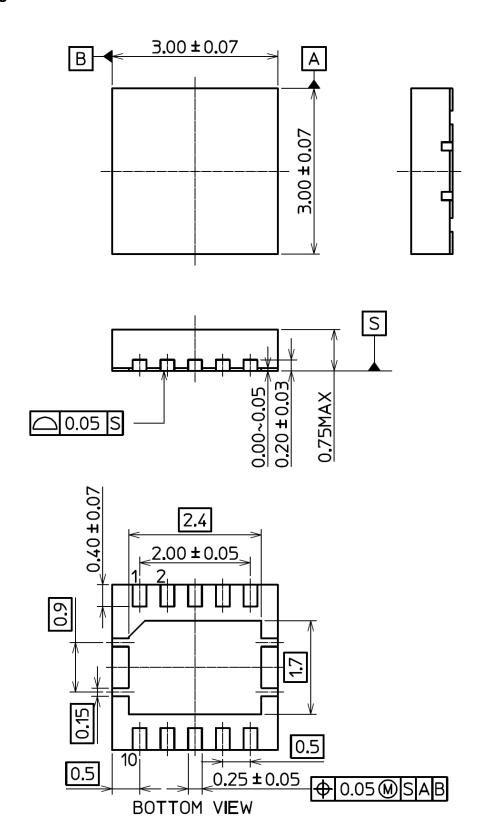






Package Dimensions

Unit: mm



Weight: 0.02g(typ.)



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